QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

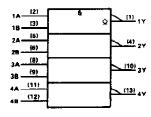
These devices contain four independent 2-input NAND gates. The open-collector outputs require pull-up resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher VOH levels.

The SN5401 and SN54LS01 are characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to $125\,^{\circ}\text{C}$. The SN7401 and SN74LS01 are characterized for operation from $0\,^{\circ}\text{C}$ to $70\,^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Υ
Н	н	L
L	X	Н
×	L	н

logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

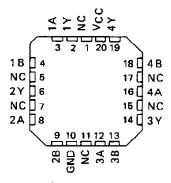
SN5401 . . . J PACKAGE SN54LS01 . . . J OR W PACKAGE SN7401 . . . N PACKAGE SN74LS01 . . . D OR N PACKAGE (TOP VIEW)

1Y	Пı	U14 Vcc
1A	\square 2	13 4 Y
1B	□3	12 🗆 4 B
2Y	□4	11 AA
2A	₫5	10 3Y
2B	□6	9∐ 3B
GND	□ 7	8 ∐ 3A

SN5401 . . , W PACKAGE (TOP VIEW)

	_	
1 A	ים	U 14] 4Y
1 B	\square^2	13 🕽 4 B
1 Y	₫3	12 AA
V c c	□4	סאם ⊈יו
2 Y	□5	10 Д 3 В
2A	4 6	9∐ 3A
2 B	口7	8 🗖 3 Ƴ

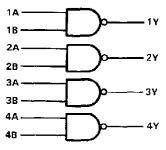
SN54LS01 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

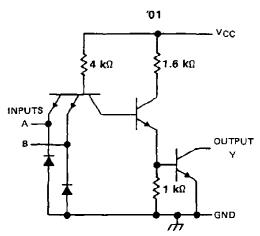
QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

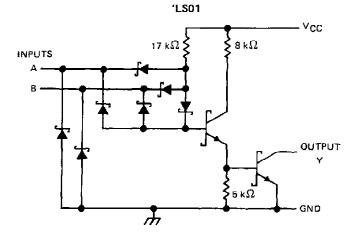
logic diagram (positive logic)



positive logic; $Y = \overline{A \cdot B}$ or $Y = \overline{A} + \overline{B}$

schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1): '0)1, 'LS()1	 	 		 <i>.</i>	 			7	V
Input voltage: '01											
'LSO1			 	 		 	 			7	V
Off-state output voltage			 	 		 	 		. . .	7	٧
Operating free-air temperature range:	SN54'		 	 		 	 ~	55°	C to	125	°C
	SN74'		 	 		 	 	. 0	°C to	o 70	°C
Storage temperature range	<i>.</i>		 	 	.	 	 _	65°	C to	150	٥C

NOTE 1: Voltage values are with respect to network ground terminals.

SN5401, SN7401 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

		SN5401			SN7401		UNIT
	MIN	NOM	MAX	MIN	NOM	мах	UNIT
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
V _{IH} High-level input voltage	2		-	2			٧
VIL Low-level input voltage			0.8			0.8	V
VOH High-level output voltage			5.5			5.5	V
IOL Low-level output current			16			16	mA
TA Operating free-air temperature	- 55		125	0	·	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST CONDITIONS [†]	SN5401	SN7401	UNIT
PARAMETER	TEST CONDITIONS.	MIN TYP# MAX	MIN TYP‡ MAX	UNIT
Vik	V _{CC} = MIN, _I = -12 mA	- 1.5	-1.5	V
	VCC = MIN, VIL = 0.8 V, VOH = 5.5 V		0.25	- ^
Іон	VCC = MIN, VIL = 0.7 V, VOH = 5.5 V	0.25		mA
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 16 mA	0.2 0.4	0.2 0.4	V
lj .	VCC = MAX, VI = 5.5 V	1	1	mΑ
lH.	$V_{CC} = MAX$, $V_{I} = 2.4 \text{ V}$	40	40	μΑ
IIL .	V _{CC} = MAX, V _I = 0.4 V	-1.6	-1.6	mA
І ссн	$V_{CC} = MAX, V_I = 0$	4 8	4 8	mA
¹ CCL	$V_{CC} = MAX$, $V_{\parallel} = 4.5 \text{ V}$	12 22	12 22	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	T O (OUTPUT)	TEST COND	DITIONS	MIN TY	P MAX	TINU
[₹] PLH	A or B	V	RL=4kΩ,	C _L = 15 pF	;	35 55	ns
^t PHL		,	R _L = 400 Ω,	C _L = 15 pF		8 15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

SN54LS01, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

		SN54LS	01		SN74LS	301	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC} Supply voltage	4,5	5	5.5	4.75	5	5.25	٧
V _{IH} High-level input voltage	2			2			V
VIL Low-level input voltage		-	0.7			0.8	V
VOH High-level output voltage			5.5			5.5	V
IOL Low-level output current			4			8	mА
TA Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

040445750	ţ	TEST CONDI	TIONET		SN54LS	01	ļ .	SN74LS	101	
PARAMETER	į	IESI CONDI	TIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
Vik	V _{CC} - MIN,	I _I = ~ 18 mA				- 1.5			- 1.5	V
•он	V _{CC} = MIN,	VIL = MAX,	V _{OH} = 5.5 ∨			0.1			0.1	mA
14	VCC = MIN,	V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
V _{OL}	V _{CC} = MIN,	V _{IH} = 2 V,	IOL - 8 mA					0.35	0.5	
41	VCC = MAX.	V _I = 7 V				0.1			0.1	mA
ЙH	V _{CC} = MAX,	V ₁ = 2.7 V			_	20			20	μА
412	V _{CC} = MAX,	V ₁ = 0.4 V	· · · · · · · · · · · · · · · · · · ·			- 0.4			- 0.4	mA
1ссн	VCC = MAX,	V _I = 0			0.8	1.6		0.8	1.6	mΑ
1CCL	V _{CC} = MAX,	V ₁ = 4.5 V			2.4	4.4		2.4	4.4	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST COM	NDITIONS	MłN	TYP	MAX	UNIT
tPLH .	A or B	·	R ₁ = 2 kΩ,	C _L = 15 pF		17	32	ns
[‡] PHL	70.0		11[- 2 K32,	C[13 pi		15	28	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN5401J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5401J	Samples
SN54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS01J	Samples
SN54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS01J	Samples
SNJ5401J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401J	Samples
SNJ5401J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401J	Samples
SNJ5401W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401W	Samples
SNJ5401W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401W	Samples
SNJ54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01J	Samples
SNJ54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01J	Samples
SNJ54LS01W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01W	Samples
SNJ54LS01W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: Til defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".



PACKAGE OPTION ADDENDUM

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Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

www.ti.com 5-Dec-2023

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SNJ5401W	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54LS01W	W	CFP	14	25	506.98	26.16	6220	NA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



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